imall

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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T-1 (3mm) SOLID STATE LAMP

Part Number: WP710A10SGD14V

Super Bright Green

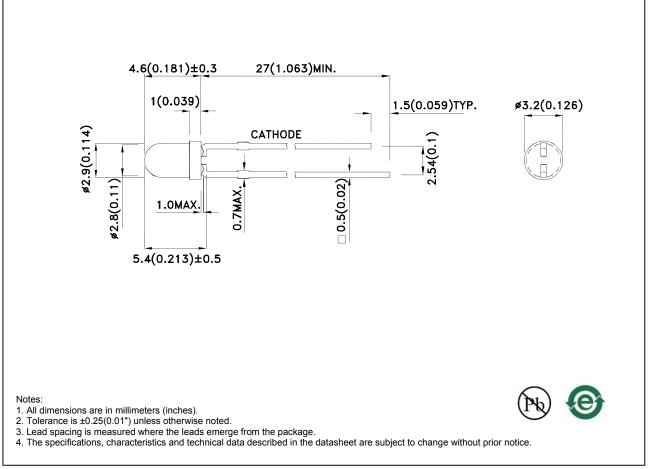
Features

- Low power consumption.
- Popular T-1 diameter package.
- General purpose leads.
- Reliable and rugged.
- Long life solid state reliability.
- Available on tape and reel.
- 14V internal resistor.
- RoHS compliant.

Description

The Super Bright Green source color devices are made with Gallium Phosphide Green Light Emitting Diode.

Package Dimensions



SPEC NO: DSAL0545 APPROVED: WYNEC REV NO: V.2 CHECKED: Allen Liu DATE: MAR/05/2011 DRAWN: J.Yu PAGE: 1 OF 6 ERP: 1101029218

Selection Guide

Part No.	Dice	Lens Type	lv (mcd) [2] V= 14V		Viewing Angle [1]		
			Min.	Тур.	201/2		
WP710A10SGD14V	Super Bright Green (GaP)	Green Diffused	8	20	40°		

Notes:

θ1/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
Luminous intensity/ luminous Flux: +/-15%.

Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Device	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Super Bright Green	565		nm	VF=14V
λD [1]	Dominant Wavelength	Super Bright Green	568		nm	VF=14V
Δλ1/2	Spectral Line Half-width	Super Bright Green	30		nm	VF=14V
lf	Forward Current	Super Bright Green	10.5	13.5	mA	VF=14V
lr	Reverse Current	Super Bright Green		10	uA	VR = 5V

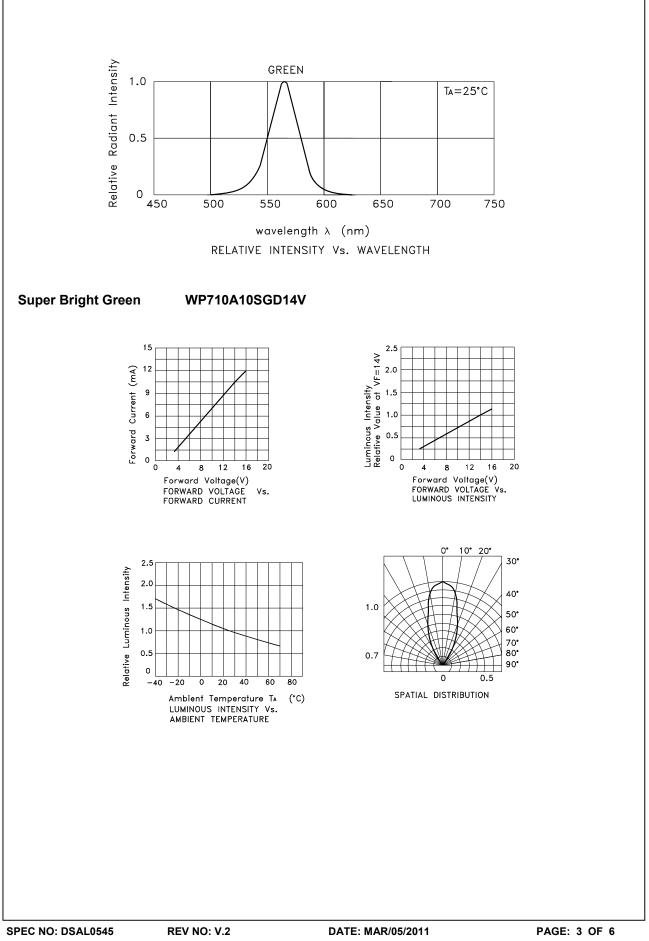
Note: 1.Wavelength: +/-1nm.

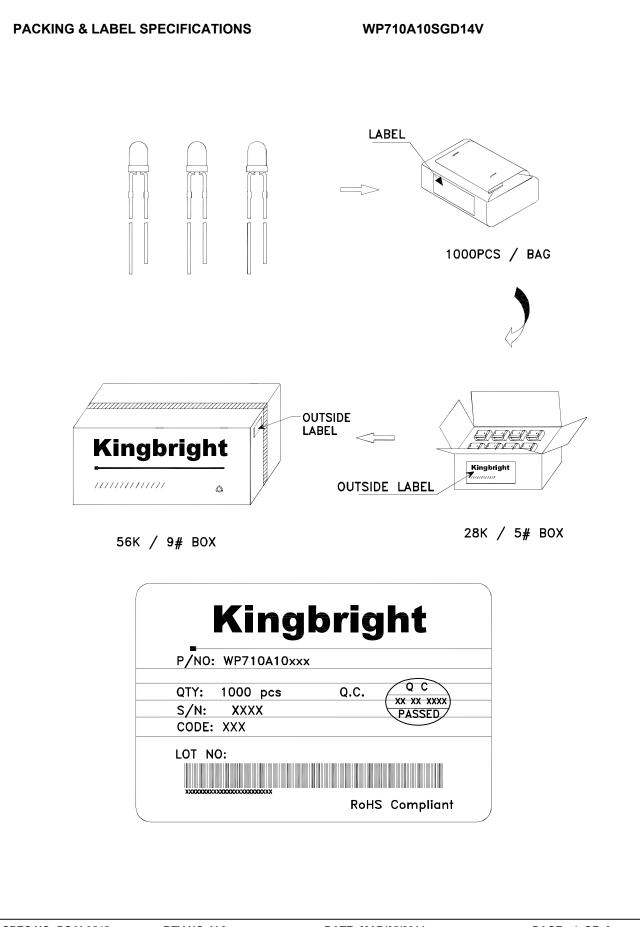
Absolute Maximum Ratings at TA=25°C

Super Bright Green		
160	mW	
16		
5	V	
-40°C To +70°C		
-40°C To +85°C		
260°C For 3 Seconds		
260°C For 5 Seconds		
	160 16 5 -40°C To +70°C -40°C To +85°C 260°C For 3 Seconds	

Notes:

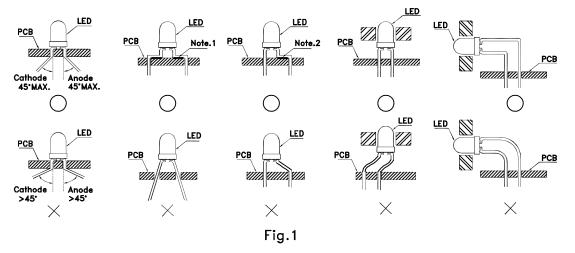
2mm below package base.
5mm below package base.



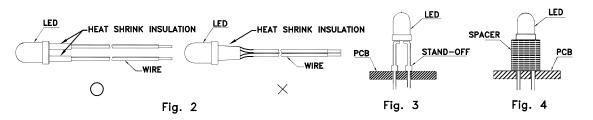


PRECAUTIONS

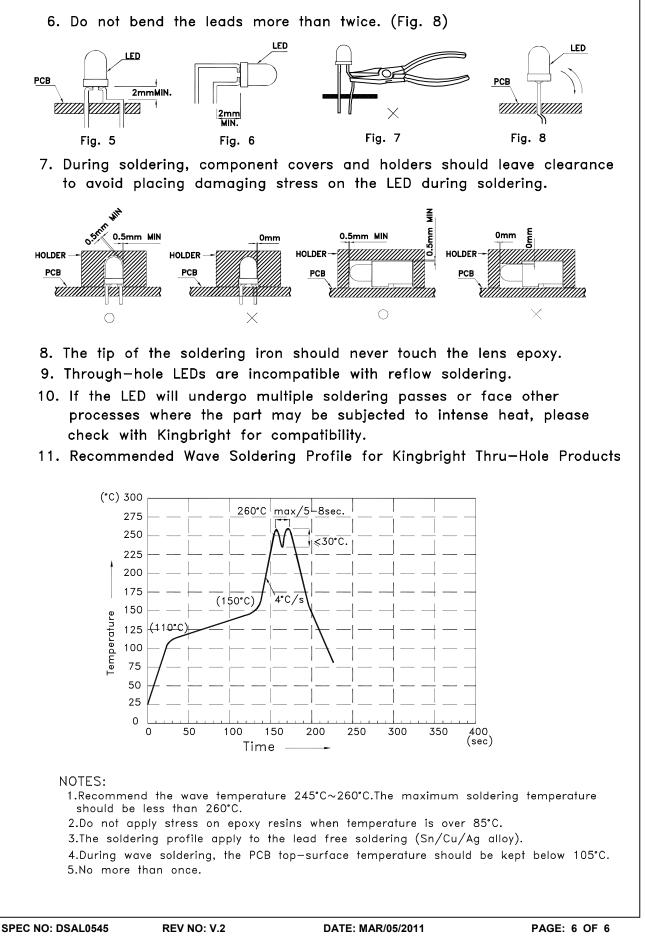
1. The lead pitch of the LED must match the pitch of the mounting holes on the PCB during component placement. Lead-forming may be required to insure the lead pitch matches the hole pitch. Refer to the figure below for proper lead forming procedures. (Fig. 1)



- \supset " Correct mounting method "imes " Incorrect mounting method
- 2. When soldering wire to the LED, use individual heat—shrink tubing to insulate the exposed leads to prevent accidental contact short—circuit. (Fig.2)
- 3.Use stand-offs (Fig.3) or spacers (Fig.4) to securely position the LED above the PCB.



- 4. Maintain a minimum of 2mm clearance between the base of the LED lens and the first lead bend. (Fig. 5 and 6)
- 5. During lead forming, use tools or jigs to hold the leads securely so that the bending force will not be transmitted to the LED lens and its internal structures. Do not perform lead forming once the component has been mounted onto the PCB. (Fig. 7)



DATE: MAR/05/2011 DRAWN: J.Yu